

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of: John Commander, et al. Art Unit: 1753  
Serial No.: 10/091,106  
Filed: March 5, 2002  
Confirmation No.: 5919  
For: DEFECT REDUCTION IN ELECTRODEPOSITED COPPER FOR  
SEMICONDUCTOR APPLICATIONS  
Examiner: Edna Wong

October 15, 2007

**AMENDMENT K AFTER FINAL**

In response to the Office action of October 9, 2007, please consider the following amendments and remarks.

Amendments to the claims are reflected in the listing of the claims that begins on page 2 of this paper.

Remarks begin on page 7 of this paper.

Conclusion begins on page 10 of this paper.